SAB3035

GENERAL DESCRIPTION

The SAB3035 provides closed-loop digital tuning of TV receivers, with or without a.f.c., as required. It also controls up to 8 analogue functions, 4 general purpose I/O ports and 4 high-current outputs for tuner band selection.

The IC is used in conjunction with a microcomputer from the MAB8400 family and is controlled via a two-wire, bidirectional I²C bus.

Features

- Combined analogue and digital circuitry minimizes the number of additional interfacing components required
- Frequency measurement with resolution of 50 kHz
- Selectable prescaler divisor of 64 or 256
- 32 V tuning voltage amplifier
- 4 high-current outputs for direct band selection
- 8 static digital to analogue convertors (DACs) for control of analogue functions
- Four general purpose input/output (I/O) ports
- Tuning with control of speed and direction
- Tuning with or without a.f.c.
- Single-pin, 4 MHz on-chip oscillator
- 12 C bus slave transceiver

QUICK REFERENCE DATA

Supply voltages			
(pin 16)	V_{P1}	typ.	12 V
(pin 22)	V_{P2}	typ.	13 V
(pin 17)	V_{P3}	typ.	32 V
Supply currents (no outputs loaded)			
(pin 16)	l _{P1}	typ.	32 mA
(pin 22)	I _{P2}	typ.	0.1 mA
(pin 17)	lp3	typ.	0,6 mA
Total power dissipation	P_{tot}	typ.	400 mW
Operating ambient temperature range	T _{amb}	–20	to +70 °C

PACKAGE OUTLINE

28-lead DIL; plastic (SOT-117).

FLL TV TUNING CIRCUIT

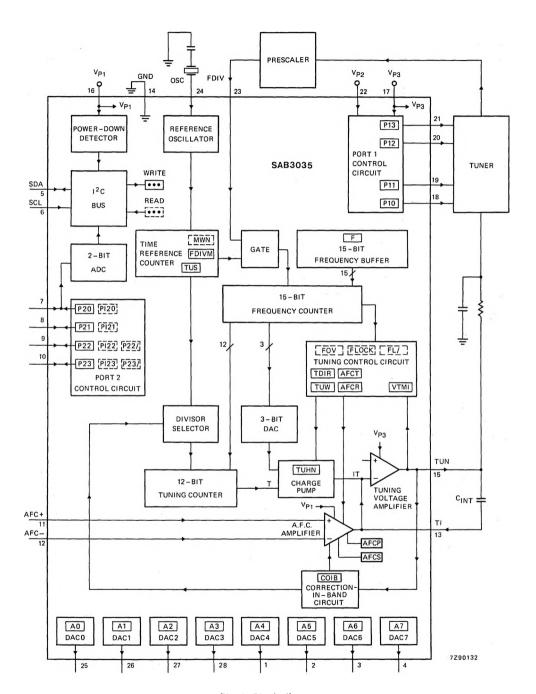


Fig. 1 Block diagram.

SAB3035

FLL TV TUNING CIRCUIT

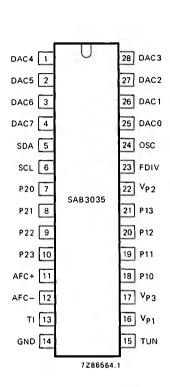


Fig. 2 Pinning diagram.

PIN	NING	
1	DAC4	
2	DAC5	outputs of static DACs
3	DAC6	outputs of state Brees
4	DAC7	
5	SDA	serial data line I^2 C bus
6	SCL	serial clock line
7	P20	
8	P21	general purpose
9	P22	input/output ports
10	P23	
11	AFC+	a.f.c. inputs
12	AFC-	a.r.c. inputs
13	TI	tuning voltage amplifier inverting input
14	GND	ground
15	TUN	tuning voltage amplifier output
16	V_{P1}	+12 V supply voltage
, 17	V _{P3}	+32 V supply for tuning voltage amplifier
18	P10	
19	P11	High-current band-selection output
20	P12	ports
21	P13	
22	V _{P2}	positive supply for high-current band- selection output circuits
23	FDIV	input from prescaler
24	OSC	crystal oscillator input
25	DAC0	
26	DAC1	outputs of static DACs
27	DAC2	outputs of static DAOs
28	DAC3	

FLL TV TUNING CIRCUIT

FUNCTIONAL DESCRIPTION

The SAB3035 is a monolithic computer interface which provides tuning and control functions and operates in conjunction with a microcomputer via an I²C bus.

Tuning

This is performed using frequency-locked loop digital control. Data corresponding to the required tuner frequency is stored in a 15-bit frequency buffer. The actual tuner frequency, divided by a factor of 256 (or by 64) by a prescaler, is applied via a gate to a 15-bit frequency counter. This input (FDIV) is measured over a period controlled by a time reference counter and is compared with the contents of the frequency buffer. The result of the comparison is used to control the tuning voltage so that the tuner frequency equals the contents of the frequency buffer multiplied by 50 kHz within a programmable tuning window (TUW).

The system cycles over a period of 6.4 ms (or 2.56 ms), controlled by the time reference counter which is clocked by an on-chip 4 MHz reference oscillator. Regulation of the tuning voltage is performed by a charge pump frequency-locked loop system. The charge IT flowing into the tuning voltage amplifier is controlled by the tuning counter, 3-bit DAC and the charge pump circuit. The charge IT is linear with the frequency deviation Δf in steps of 50 kHz. For loop gain control, the relationship $\Delta IT/\Delta f$ is programmable. In the normal mode (when control bits TUHN0 and TUHN1 are both at logic 1, see OPERATION), the minimum charge IT at $\Delta f = 50$ kHz equals 250 μ A μ s (typical).

By programming the tuning sensitivity bits (TUS), the charge IT can be doubled up to 6 times. If correction-in-band (COIB) is programmed, the charge can be further doubled up to three times in relation to the tuning voltage level. From this, the maximum charge IT at $\Delta f = 50 \text{ kHz}$ equals $2^6 \times 2^3 \times 250 \,\mu\text{A} \,\mu\text{S}$ (typical).

The maximum tuning current I is 875 μ A (typical). In the tuning-hold (TUHN) mode (TUHN is active LOW), the tuning current I is reduced and as a consequence the charge into the tuning amplifier is also reduced.

An in-lock situation can be detected by reading FLOCK. When the tuner oscillator frequency is within the programmable tuning window (TUW), FLOCK is set to logic 1. If the frequency is also within the programmable a.f.c. hold range (AFCR), which always occurs if AFCR is wider than TUW, control bit AFCT can be set to logic 1. When set, digital tuning will be switched off, a.f.c. will be switched on and FLOCK will stay at logic 1 as long as the oscillator frequency is within AFCR. If the frequency of the tuning oscillator does not remain within AFCR, AFCT is cleared automatically and the system reverts to digital tuning. To be able to detect this situation, the occurrence of positive and negative transitions in the FLOCK signal can be read (FL/1N and FL/0N). AFCT can also be cleared by programming the AFCT bit to logic 0.

The a.f.c. has programmable polarity and transconductance; the latter can be doubled up to 3 times, depending on the tuning voltage level if correction-in-band is used.

The direction of tuning is programmable by using control bits TDIRD (tuning direction down) and TDIRU (tuning direction up). If a tuner enters a region in which oscillation stops, then, providing the prescaler remains stable, no FDIV signal is supplied to CITAC. In this situation the system will tune up, moving away from frequency lock-in. This situation is avoided by setting TDIRD which causes the system to tune down. In normal operation TDIRD must be cleared.

If a tuner stops oscillating and the prescaler becomes unstable by going into self-oscillation at a very high frequency, the system will react by tuning down, moving away from frequency lock-in. To overcome this, the system can be forced to tune up at the lowest sensitivity (TUS) value, by setting TDIRU.

Setting both TDIRD and TDIRU causes the digital tuning to be interrupted and a.f.c. to be switched on.

The minimum tuning voltage which can be generated during digital tuning is programmable by VTMI to prevent the tuner being driven into an unspecified low tuning voltage region.

Control

For tuner band selection there are four outputs P10 to P13 which are capable of sourcing up to 50 mA at a voltage drop of less than 600 mV with respect to the separate power supply input Vp2.

For additional digital control, four open collector I/O ports P20 to P23 are provided. Ports P22 and P23 are capable of detecting positive and negative transitions in their input signals. With the aid of port P20, up to three independent module addresses can be programmed.

Eight 6-bit digital-to-analogue converters DAC0 to DAC7 are provided for analogue control.

Reset

CITAC goes into the power-down-reset mode when V_{P1} is below 8.5 V (typical). In this mode all registers are set to a defined state. Reset can also be programmed.

OPERATION

Write

CITAC is controlled via a bidirectional two-wire I^2C bus; the I^2C bus is specified in our data handbook "ICs for digital systems in radio, audio, and video equipment". For programming, a module address, R/\overline{W} bit (logic 0), an instruction byte and a data/control byte are written into CITAC in the format shown in Fig. 3.

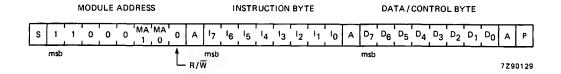


Fig. 3 12 C bus write format.

The module address bits MA1, MA0 are used to give a 2-bit module address as a function of the voltage at port P20 as shown in Table 1.

Acknowledge (A) is generated by CITAC only when a valid address is received and the device is not in the power-down-reset mode ($V_{P1} > 8.5 \text{ V (typical)}$).

Table 1 Valid module addresses

MA1	MAO	P20
0	0	don't care
0	1	GND
1	0	½Vp1
1	1	Vp1

DATA/CONTROL BYTE

OPERATION (continued)

Tuning

Tuning is controlled by the instruction and data/control bytes as shown in Fig. 4.

INSTRUCTION BYTE

											יאכ	A, 0011				
	17	16	15	14	13	12	11	10	D ₇	D ₆	D ₅	D ₄	D3	D ₂	D ₁	D ₀
freq.	1	F14	F13	F12	F11	F10	F9	F8	F7	F6	F5	F4	F3	F2	F1	F0
TCD0	0	0	1	0	1	0	0	1	AFCT	VTMI0	AFCR1	AFCR0	TUHN1	TUHN0	TUW1	TUWO
TCD1	0	0	1	0	1	0	1.	0	VTMI1	COIB1	COIBO	AFCS1	AFCS0	TUS2	TUS1	TUSO
TCD2	0	0	1	0	1	0	1	1	0	0	0	0	AFCP	FDIVM	TDIRD	TDIRU

Fig. 4 Tuning control format.

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Frequency

Frequency is set when bit I₇ of the instruction byte is set to logic 1; the remainder of this byte together with the data/control byte are loaded into the frequency buffer. The frequency to which the tuner oscillator is regulated equals the decimal representation of the 15-bit word multiplied by 50 kHz. All frequency bits are set to logic 1 at reset.

Tuning hold

The TUHN bits are used to decrease the maximum tuning current and, as a consequence, the minimum charge IT (at $\Delta f = 50 \text{ kHz}$) into the tuning amplifier.

Table 2 Tuning current control

TUHN1	TUHN0	typ. I _{max} μΑ	typ. IT _{min} μΑ μs	typ. ΔV_{TUNmin} at $C_{INT} = 1 \mu F$ μV
0	0	3.5*	1*	1*
0	1	29	8	8
1	0	110	30	30
1	1	875	250	250

^{*} Values after reset.

During tuning but before lock-in, the highest current value should be selected. After lock-in the current may be reduced to decrease the tuning voltage ripple.

The lowest current value should not be used for tuning due to the input bias current of the tuning voltage amplifier (max. 5 nA). However it is good practice to program the lowest current value during tuner band switching.

Tuning sensitivity

To be able to program an optimum loop gain, the charge IT can be programmed by changing T using tuning sensitivity (TUS). Table 3 shows the minimum charge IT obtained by programming the TUS bits at $\Delta f = 50 \text{ kHz}$; TUHN0 and TUHN1 = logic 1.

Table 3 Minimum charge IT as a function of TUS

 $\Delta f = 50 \text{ kHz}$; TUHN0 = logic 1; TUHN1 = logic 1

TUS2	TUS1	TUS0	typ. IT _{min} mA μs	typ. ΔV_{TUNmin} at $C_{INT} = 1 \mu F$ mV
0	О	0	0.25*	0,25*
0	0	1 .	0.5	0. 5
0	1	0	1	1
0	1	1	2	2
1	0	0	4	4
1	0	1	8	8
1	1	0	16	16

^{*} Values after reset.

Correction-in-band

This control is used to correct the loop gain of the tuning system to reduce in-band variations due to a non-linear voltage/frequency characteristic of the tuner. Correction-in-band (COIB) controls the time T of the charge equation IT and takes into account the tuning voltage V_{TUN} to give charge multiplying factors as shown in Table 4.

Table 4 Programming correction-in-band

COIB1	COIB0	charge mu < 12 V	Itiplying factors at t	ypical values of V ₇ 18 to 24 V	ON at: > 24 V
0 0 1	0 1 0	1* 1 1	1* 1	1* 1 2	1* 2 4
1	1	1	2	4	8

^{*} Values after reset.

The transconductance multiplying factor of the a.f.c. amplifier is similar when COIB is used, except for the lowest transconductance which is not affected.

Tuning window

Digital tuning is interrupted and FLOCK is set to logic 1 (in-lock) when the absolute deviation $|\Delta f|$ between the tuner oscillator frequency and the programmed frequency is smaller than the programmed TUW value (see Table 5). If $|\Delta f|$ is up to 50 kHz above the values listed in Table 5, it is possible for the system to be locked depending on the phase relationship between FDIV and the reference counter.

Table 5 Tuning window programming

TUW1	TUWO	∆f (kHz)	tuning window (kHz)
0	0	0*	0*
0	1	50	100
1	0	150	300

^{*} Values after reset.

OPERATION (continued)

A.F.C.

When AFCT is set to logic 1 it will not be cleared and the a.f.c. will remain on as long as $|\Delta f|$ is less than the value programmed for the a.f.c. hold range AFCR (see Table 6). It is possible for the a.f.c. to remain on for values of up to 50 kHz more than the programmed value depending on the phase relationship between FDIV and the reference counter.

Table 6 A.F.C. hold range programming

AFCR1	AFCR0	Δf (kHz)	a.f.c. hold range (kHz)
0	0	0*	0*
0	1 1	350	700
1	0	750	1500

^{*} Values after reset

Transconductance

The transconductance (g) of the a.f.c. amplifier is programmed via the a.f.c. sensitivity bits AFCS as shown in Table 7.

Table 7 Transconductance programming

AFCS1	AFCS0	typ. transconductance (μΑ/V)
0	0	0.25*
О	1	25
1) o	50
1	1	100

^{*} Value after reset.

A.F.C. polarity

If a positive differential input voltage is applied to the (switched on) a.f.c. amplifier, the tuning voltage V_{TUN} falls when the a.f.c. polarity bit AFCP is at logic 0 (value after reset). At AFCP = logic 1, V_{TUN} rises.

Minimum tuning voltage

Both minimum tuning voltage control bits, VTMI1 and VTMI0, are at logic 0 after reset. Further details are given in CHARACTERISTICS.

Frequency measuring window

The frequency measuring window which is programmed must correspond with the division factor of the prescaler in use (see Table 8).

Table 8 Frequency measuring window programming

FDIVM	prescaler division factor	cycle period (ms)	measuring window (ms)
0	256	6.4*	5,12*
	64	2.56	1,28

^{*} Values after reset.

Tuning direction

Both tuning direction bits, TDIRU (up) and TDIRD (down), are at logic 0 after reset.

Control

The instruction bytes POD (port output data) and DACX (digital-to-analogue converter control) are shown in Fig. 5, together with the corresponding data/control bytes. Control is implemented as follows:

P13, P12, P11, P10 Band select outputs. If a logic 1 is programmed on any of the POD bits D3 to

Do, the relevant output goes HIGH. All outputs are LOW after reset.

P23, P22, P21, P20 Open collector I/O ports, If a logic 0 is programmed on any of the POD bits

D₇ to D₄, the relevant output is forced LOW. All outputs are at logic 1 after

reset (high impedance state).

DACX Digital-to-analogue converters. The digital-to-analogue converter selected

corresponds to the decimal equivalent of the DACX bits X2, X1, X0. The output voltage of the selected DAC is set by programming the bits AX5 to AX0; the lowest output voltage is programmed with all data AX5 to AX0 at

logic 0, or after reset has been activated.

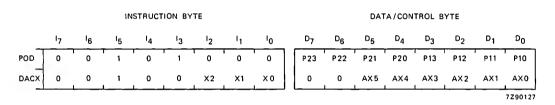


Fig. 5 Control programming.

Read

Information is read from CITAC when the R/W bit is set to logic 1. An acknowledge must be generated by the master after each data byte to allow transmission to continue. If no acknowledge is generated by the master the slave (CITAC) stops transmitting. The format of the information bytes is shown in Fig. 6.

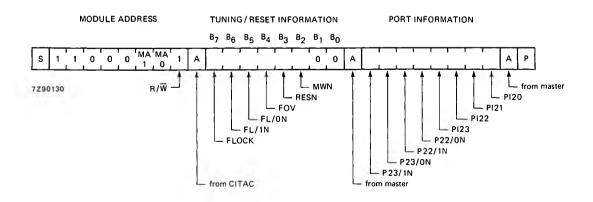


Fig. 6 Information byte format.

OPERATION (continued)

Tuning/reset information bits

FLOCK Set to logic 1 when the tuning oscillator frequency is within the programmed tuning

window.

FL/1N Set to logic 0 (active LOW) when FLOCK changes from 0 to 1 and is reset to logic 1

automatically after tuning information has been read.

FL/ON As for FL/1N but is set to logic 0 when FLOCK changes from 1 to 0.

FOV Indicates frequency overflow. When the tuner oscillator frequency is too high with

respect to the programmed frequency, FOV is at logic 1, and when too low, FOV

is at logic 0. FOV is not valid when TDIRU and/or TDIRD are set to logic 1.

Set to logic 0 (active LOW) by a programmed reset or a power-down-reset. It is reset to logic 1 automatically after tuning/reset information has been read.

MWN (frequency measuring window, active LOW) is at logic 1 for a period of

1.28 ms, during which time the results of frequency measurement are processed. This time is independent of the cycle period. During the remaining time, MWN is

at logic 0 and the received frequency is measured.

When slightly different frequencies are programmed repeatedly and a.f.c. is switched on, the received frequency can be measured using FOV and FLOCK. To prevent the frequency counter and frequency buffer being loaded at the same time, frequency should be programmed only during the period of MWN = logic 0.

Port information bits

P23/1N, P22/1N Set to logic 0 (active LOW) at a LOW-to-HIGH transition in the input voltage on

P23 and P22 respectively. Both are reset to logic 1 after the port information has

been read.

P23/0N, P22/0N As for P23/1N and P22/1N but are set to logic 0 at a HIGH-to-LOW transition.

PI23, PI22, PI21, Indicate input voltage levels at P23, P22, P21 and P20 respectively. A logic 1

PI20 indicates a HIGH input level.

Reset

RESN

The programming to reset all registers is shown in Fig. 7. Reset is activated only at data byte HEX 06. Acknowledge is generated at every byte, provided that CITAC is not in the power-down-reset mode. After the general call address byte, transmission of more than one data byte is not allowed.

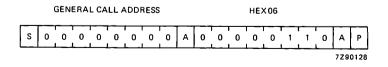


Fig. 7 Reset programming.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage ranges:					
(pin 16)	V _{P1}	-0.3	to	+18	V
(pin 22)	V _{P2}	-0.3	to	+ 18	V
(pin 17)	V _{P3}	-0.3	to	+36	V
Input/output voltage ranges:					
(pin 5)	V_{SDA}	-0.3	to	+ 18	V
(pin 6)	V _{SCL}	-0.3	to	+ 18	V
(pins 7 to 10)	V _{P2X}	-0.3	to	+ 18	٧
(pins 11 and 12)	VAFC+, AFC-	-0.3	to	V _{P1} *	V
(pin 13)	VTI	-0.3	to	V _{P1} *	٧
(pin 15)	v_{TUN}	-0.3	to	V _{P3} *	V
(pins 18 to 21)	V _{P1X}	-0.3	to	V _{P2} **	٧.
(pin 23)	v_{FDIV}	-0.3	to	V _{P1} *	V
(pin 24)	Vosc	-0.3	to	+5	٧
(pins 1 to 4 and 25 to 28)	VDACX	-0.3	to	V _{P1} *	V
Total power dissipation	P _{tot}	max.	1	1000	mW
Storage temperature range	T _{stg}	– 55	to 4	+125	οС
Operating ambient temperature range	T _{amb}	–20	to	+ 70	oC

^{*} Pin voltage may exceed supply voltage if current is limited to 10 mA.

^{**} Pin voltage must not exceed 18 V but may exceed Vp2 if current is limited to 200 mA.

CHARACTERISTICS

Tamb = 25 °C; VP1, VP2, VP3 at typical voltages, unless otherwise specified

parameter	symbol	min.	typ.	max.	unit
Supply voltages	V _{P1}	10.5	12	13.5	V
	V _{P2}	4.7	13	16	٧
	V _{P3}	30	32	35	٧
Supply currents (no outputs loaded)	I _{P1}	20	32	50	mA
	I _{P2}	0	_ '	0.1	mΑ
	I _{P3}	0.2	0.6	2	mA
Additional supply currents (A)	I _{P2A}	-2	_	IOHP1X	mA
(note 1)	IP3A	0.2		2	mΑ
Total power dissipation	P _{tot}		400	_	mW
Operating ambient temperature	T _{amb}	-20	-	+ 70	°C
I ² C bus inputs/outputs					
SDA input (pin 5); SCL input (pin 6)			(
Input voltage HIGH (note 2)	VIH	3		V _{P1} -1	٧
Input voltage LOW	VIL	-0.3	_	1.5	V
Input current HIGH (note 2)	TiH	_	_	10	μΑ
Input current LOW (note 2)	HL	_	_	10	μΑ
SDA output (pin 5, open collector)					
Output voltage LOW at IOL = 3 mA	VOL	_	_	0.4	V
Maximum output sink current	lOL	-	5	_	mA
Open collector I/O ports					
P20, P21, P22, P23 (pins 7 to 10, open collector)			_		
Input voltage HIGH	VIH	2	-	16	v
Input voltage LOW	VIL	-0.3	_	8.0	v
Input current HIGH	TIH.	_	_	25	μΑ
Input current LOW	-116	_	_	25	μΑ
Output voltage LOW at IOL = 2 mA	VOL	_	_	0.4	v
Maximum output sink current	IOL	-	4	_	mA

parameter	symbol	min.	typ.	max.	unit
A.F.C. amplifier					
Inputs AFC+, AFC— (pins 11, 12)			,		1
Transconductance for input voltages up to 1 V differential:					
AFCS1 AFCS2 0 0 1 1 1 1 0 1 1 Tolerance of transconductance multiplying factor (2, 4 or 8)	900 901 910 911	100 15 30 60	250 25 50 100	800 35 70 140	nA/V μΑ/V μΑ/V μΑ/V
when correction-in-band is used	ΔM_g	-20	_	+ 20	%
Input offset voltage	V _{loff}	–75	-	+ 75	mV
Common mode input voltage	V _{com}	3	-	V _{P1} -2.5	V
Common mode rejection ratio	CMRR	-	50	_	dB
Power supply (V _{P1}) rejection ratio	PSRR	-	50	_	dB
Input current	11	-	-	500	nA
Tuning voltage amplifier					
Input TI, output TUN (pins 13, 15) Maximum output voltage at $I_{load} = \pm 2.5 \text{ mA}$ Minimum output voltage at $I_{load} = \pm 2.5 \text{ mA}$: VTMI1 VTMI0	VTUN	V _{P3} -1.6	-	V _{P3} -0.4	V
0 0	V _{TM00}	300	-	500	mV
1 0	VTM10	450	-	650	mV
1 1	VTM11	650	-	900	mV
Maximum output source current	-ITUNH	2.5	-	8	mA
Maximum output sink current	ITUNL	_	40	-	mA
Input bias current	l _{Tl}	- 5	-	+5	nΑ
Power supply (V _{P3}) rejection ratio	PSRR	-	60	-	dB

CHARACTERISTICS (continued)

parameter			symbol	mi n .	typ.	max.	unit
Tuning voltage	amplifier (continued)						
Minimum char	ge IT to tuning voltage an	nplifier	ĺ				
TUHN1	TUHN0						
0	0		CH ₀₀	0.4	1	1.7	μΑ μς
0	1		CH ₀₁	4	8	14	μΑ μς
1	0 1		CH ₁₀ CH ₁₁	15 130	30 250	48 370	μΑ μs μΑ μs
multiplying	harge (or ΔV _{TUN})		ΔCH	-20	_	+ 20	%
Maximum curr	ent I into tuning amplifie	r			7		
TUHN1	TUHN0			}			
0	0		1T00	1.7	3.5	5.1	μΑ
0 1	1		¹ T01	15	29	41	μΑ
1	0 1		T10 T11	65 530	110 875	160 1220	μA μA
Correction-in-b	-						
	orrection-in-band 18 V and 24 V		ΔV _{CIB}	-15	_	+ 15	%
Band-select ou	tput ports			-			
P10, P11, P12,	P13 (pins 18 to 21)						
Output voltage	HIGH at						
-10H = 50	mA (note 3)		VOH	V _{P2} -0.6	<u> </u>	-	V
Output voltage	LOW at IOL = 2 mA		VOL	<u> </u> _	_	0.4	v
Maximum outp	out source current (note 3	3)	-1он	_	130	200	mA
Maximum outp	out sink current		lOL	<u> </u> -	5	_	mA
FDIV input (p	in 23)	'a'		!			
Input voltage ((trise and tra	peak-to-peak value) su ≤ 40 ns)		V _{FDIV(p-p}	0.1	_	2	V
Duty cycle	311 - 10 110/		*FDIV(p-p) 	40		60	v %
Maximum inpu	it frequency		f	14.5	_	_	MHz
Input impedan	•		f _{max} Z _i		8	_	kΩ
	nce		C _i		5	-	~~*

parameter	symbol	min.	typ.	max.	unit
OSC input (pin 24)					
Crystal resistance at resonance (4 MHz)	RX	-	_	150	Ω
DAC outputs 0 to 7 (pins 25 to 28 and 1 to 4)				i	
Maximum output voltage (no load) at V _{P1} = 12 V (note 4)	VDH	10	3	11.5	٧
Minimum output voltage (no load) at Vp ₁ = 12 V (note 4)	V _{DL}	0.1	_	1	٧
Positive value of smallest step (1 least-significant bit)	ΔVD	0	-	350	mV
Deviation from linearity	_	_	-	0.5	٧
Output impedance at I _{load} = ± 2 mA	Zo	_	-	70	Ω
Maximum output source current	-IDH	_	_	6	mΑ
Maximum output sink current	IDL	-	8	_	mA
Power-down-reset					
Maximum supply voltage Vp1 at which power-down-reset is active	V _{PD}	7.5	_	9.5	V
V_{P1} rise-time during power-up (up to V_{PD})	t _r	5	_	_	μs
Voltage level for valid module address		:			
Voltage level at P20 (pin 7) for valid module address as a function of MA1, MA0					
MA1 MA0					
0 0	VVA00	-0.3	-	16	V
0 1	VVA01	-0.3	-	0.8	V
1 0	VVA10 VVA11	2.5 V _{P1} -0.3	-	V _{P1} -2 V _{P1}	V V

Notes to the characteristics

- 1. For each band-select output which is programmed at logic 1, sourcing a current I_{OHP1X}, the additional supply currents (A) shown must be added to I_{P2} and I_{P3} respectively.
- 2. If V_{P1} < 1 V, the input current is limited to 10 μ A at input voltages up to 16 V.
- 3. At continuous operation the output current should not exceed 50 mA. When the output is short-circuited to ground for several seconds the device may be damaged.
- 4. Values are proportional to Vp1.

FLL TV TUNING CIRCUIT

I²C BUS TIMING (Fig. 8)

12 C bus load conditions are as follows:

4 k Ω pull-up resistor to +5 V; 200 pF capacitor to GND.

All values are referred to V_{IH} = 3 V and V_{IL} = 1.5 V.

parameter	symbol	min.	typ.	max.	unit
Bus free before start	tBUF	4	_	_	μs
Start condition set-up time	tSU,STA	4	_	-	μs
Start condition hold time	tHD,STA	4		-	μs
SCL, SDA LOW period	tLOW	4	_	_	μs
SCL HIGH period	tHIGH	4	-	_	μs
SCL, SDA rise time	tR	_	_	1	μs
SCL, SDA fall time	te	-	-	0.3	μs
Data set-up time (write)	t _{SU,DAT}	1	-	_	μs
Data hold time (write)	tHD,DAT	ī- 1	_	_	μs
Acknowledge (from CITAC) set-up time	tSU,CAC	- 1	.=.	2	μs
Acknowledge (from CITAC) hold time	tHD,CAC	0	_	_	μs
Stop condition set-up time	tSU,STO	4	-	-	μs
Data set-up time (read)	tSU,RDA	_	-	2	μs
Data hold time (read)	tHD,RDA	0	-	_	μs
Acknowledge (from master) set-up time	tSU,MAC	1	_	_	μs
Acknowledge (from master) hold time	tHD, MAC	2	_		μs

Note

Timings $t_{SU,DAT}$ and $t_{HD,DAT}$ deviate from the I^2C bus specification . After reset has been activated, transmission may only be started after a 50 μ s delay.

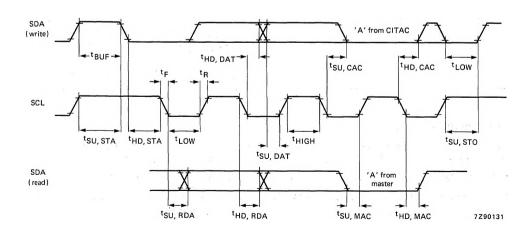


Fig. 8 I²C bus timing SAB3035.